

TG-G15-02

Heatsink silicone thermal paste grease, 15 g

- Keep your computer's CPU cool
- Practical bottle of increased volume



Features

- Thermal silicone compound (grease) for heatsinks
- Helps the heat dissipation from a CPU, chipset or processor to a heatsink
- Excellent thermal impedance
- Perfect stability will not separate, run, migrate, or bleed
- Non capacitive or electrically conductive

Packaging

Q'ty in crtn, pcs	400
Crtn volume, CUM	0.059
Crtn weight, kgs	11.87
Individual package size LxWxH:	35x30x30 mm
Carton size LxWxH:	490x350x345 mm
Country of origin	CN
Barcode	8716309102698
Customs code	3402909000

Certificates



Specifications

Net weight: 15 g (23 g in the bottle)
Dimensions: 30 (diameter) x 35 mm
Color: grey
Thermal conductivity: > 4.63 W / mK
Thermal Impedance <math><0.0087^\circ\text{C-in}^2 / \text{W}</math>
Weight loss after 96 hours @ 100°C: <math><0.15\%</math>
Permittivity @ 106 Hz: 2.4
Volume Resistivity: $5.0 \times 10E13$ (Ohmcm)
Dielectric Strength: 2.5 KV/mm
Operating Temperature: -30 ~ 280 ° C
Density: > 3.15 g/ cm³
Volatility: <math><0.15\%</math> @100 ?
The dielectric constant: > 2.4
Dissipation Factor: <math><0.005</math>
Viscosity: 12500 Pa s
Thixotropic index: 350 ± 10 1/10mm
Composites: 15% silicone compounds
Compounds: 35% of carbon
The compounds of metal oxides: 50%